

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3425628

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	YU LONG	07/29/2014
RECEIVING PARTY DATA		
Name:	UNITED TECHNOLOGIES CORPORATION	
Street Address:	1 FINANCIAL PLAZA	
City:	HARTFORD	
State/Country:	CONNECTICUT	
Postal Code:	06101	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14790941	
CORRESPONDENCE DATA		
Fax Number:	(413)731-3101	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	413-731-3100	
Email:	uspto@osheagetz.com	
Correspondent Name:	O'SHEA GETZ P.C.	
Address Line 1:	1500 MAIN STREET	
Address Line 2:	SUITE 912	
Address Line 4:	SPRINGFIELD, MASSACHUSETTS 01115	
ATTORNEY DOCKET NUMBER:	PA-0024169-US-AA	
NAME OF SUBMITTER:	PATRICK J. O'SHEA	
SIGNATURE:	/pjo/	
DATE SIGNED:	07/06/2015	
Total Attachments: 2		
source=PA-0024169-US-AA Executed Assignment#page1.tif		
source=PA-0024169-US-AA Executed Assignment#page2.tif		

ASSIGNMENT

THIS INSTRUMENT OF ASSIGNMENT WITNESSETH THAT:

WHEREAS, I, Yu Long, resident of 301 Audubon Court, New Haven, CT 06510, have invented improvements in

AN ADDITIVE MANUFACTURING SYSTEM AND METHOD OF ADDITIVE MANUFACTURE UTILIZING LAYER-BY-LAYER THERMO-MECHANICAL ANALYSIS

for which we executed an application for United States Letters Patent on even date herewith; and

WHEREAS, United Technologies Corporation, a Delaware corporation, having a place of business at 1 Financial Plaza, Hartford, CT 06101, is desirous of acquiring an interest in said invention, said application and the Letters Patent to be issued therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for and in consideration of the sum of ONE DOLLAR to each in hand paid and other good and valuable consideration, the receipt whereof is hereby acknowledged, we have sold, assigned and set over, and do hereby sell, assign and set over to said corporation, its successors or assigns, the entire right, title and interest to and in said invention in the United States and in all countries foreign to the United States, said United States application for Letters Patent therefor and in any non-provisional application that may claim said invention or priority to said application, and any divisional, continuation, and/or continuation-in-part thereof, and the Letters Patent when issued; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue the Letters Patent based upon said application to said corporation as the assignees of our entire right, title and interest to and in the same, for the sole use and behoof of said corporation, its successors or assigns.

And we also hereby covenant and agree to sign all proper papers including divisional and other applications for patents and assignments thereof in the United States and application for patents and assignments in all countries foreign to the United States, and to

execute all rightful oaths and to take any other proper action that may in the judgment of the said corporation be necessary for securing thereto full rights to said invention, all of the foregoing to be at the expense of said corporation.

IN TESTIMONY WHEREOF, I have hereunto set my hand this

29th day of July, 2014.

Yu Long
Yu Long

[Signature]
Witness